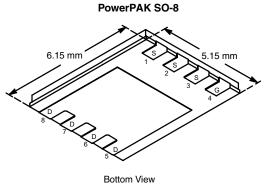


Vishay Siliconix

N-Channel 150-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	r _{DS(on)} (Ω)	I _D (A)			
150	0.085 at V _{GS} = 10 V	4.8			
	0.095 at V _{GS} = 6.0 V	4.5			



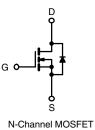
Ordering Information: Si7898DP-T1 Si7898DP-T1-E3 (Lead (Pb)-free)

FEATURES

- TrenchFET[®] Power MOSFET for Fast Switching
- New Low Thermal Resistance PowerPAK® Package with Low 1.07-mm Profile
- PWM Optimized
- 100 % Rg Tested

APPLICATIONS

- DC/DC Power Supply Primary Side Switch
- Automotive and Industrial Motor Drives



ABSOLUTE MAXIMUM RATINGS T	$_{\rm A}$ = 25 °C, unles	ss otherwise n	oted			
Parameter	Symbol	10 secs	Steady State	Unit		
Drain-Source Voltage		V _{DS}	150		V	
Gate-Source Voltage		V _{GS}	± 20			
Continuous Drain Current (T 150 °C)8	T _A = 25 °C	I-	4.8	3.0		
Continuous Drain Current $(T_J = 150 \text{ °C})^a$	T _A = 70 °C	– I _D	3.8	2.4		
Pulsed Drain Current		I _{DM}	25		А	
Avalanche Current	L = 0.1 mH	I _{AS}	10			
Continuous Source Current (Diode Conduction) ^a		I _S	4.1	1.6		
Marian David Dissidentian	T _A = 25 °C	PD	5.0	1.9	W	
Maximum Power Dissipation ^a	T _A = 70 °C	۲D	3.2	1.2	vv	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	– 55 to 150		°C	
Soldering Recommendations (Peak Temperature) ^{b,c}			260			

THERMAL RESISTANCE RATINGS Parameter Symbol Typical Maximum Unit $t \le 10$ sec 20 25 R_{thJA} Maximum Junction-to-Ambient^a Steady State 52 65 °C/W Maximum Junction-to-Case (Drain) Steady State 2.1 2.6 R_{thJC}

Notes

a. Surface Mounted on 1" x 1" FR4 Board.

b. See Solder Profile (*http://www.vishay.com/ppg?73257*). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

* Pb containing terminations are not RoHS compliant, exemptions may apply.



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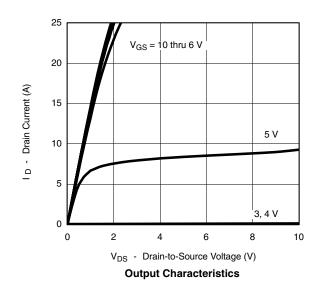


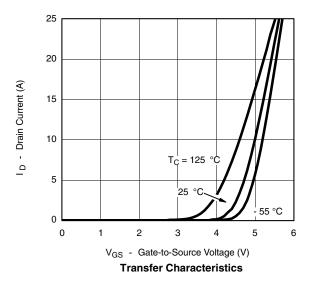
SPECIFICATIONS $T_J = 25 \text{ °C}$, unless otherwise noted									
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit			
Static				•					
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2.0		4.0	V			
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA			
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 150 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	-μΑ			
		V_{DS} = 150 V, V_{GS} = 0 V, T_{J} = 55 °C			5				
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	25			А			
	-	$V_{GS} = 10$ V, $I_{D} = 3.5$ A		0.068	0.085	Ω			
Drain-Source On-State Resistance ^a	r _{DS(on)}	$V_{GS} = 6.0 \text{ V}, I_D = 3.0 \text{ A}$		0.076	0.095				
Forward Transconductance ^a	g _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 5 \text{ A}$		15		S			
Diode Forward Voltage ^a	V _{SD}	$I_{S} = 2.5 \text{ A}, V_{GS} = 0 \text{ V}$		0.75	1.2	V			
Dynamic ^b	1 I								
Total Gate Charge	Qg			17	21	nC			
Gate-Source Charge	Q _{gs}	$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 3.5 \text{ A}$		3.2					
Gate-Drain Charge	Q _{gd}			6.0					
Gate Resistance	Rg		0.5	0.85	2.5	Ω			
Turn-On Delay Time	t _{d(on)}			9.0	14				
Rise Time	t _r	V_{DD} = 75 V, R_L = 21 Ω		10	15				
Turn-Off Delay Time t _{d(off)}) $I_D \cong 3.5 \text{ A}, V_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{G}} = 6 \Omega$		24	35	ns			
Fall Time	t _f			17	25				
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 2.5 A, di/dt = 100 A/μs		45	70				

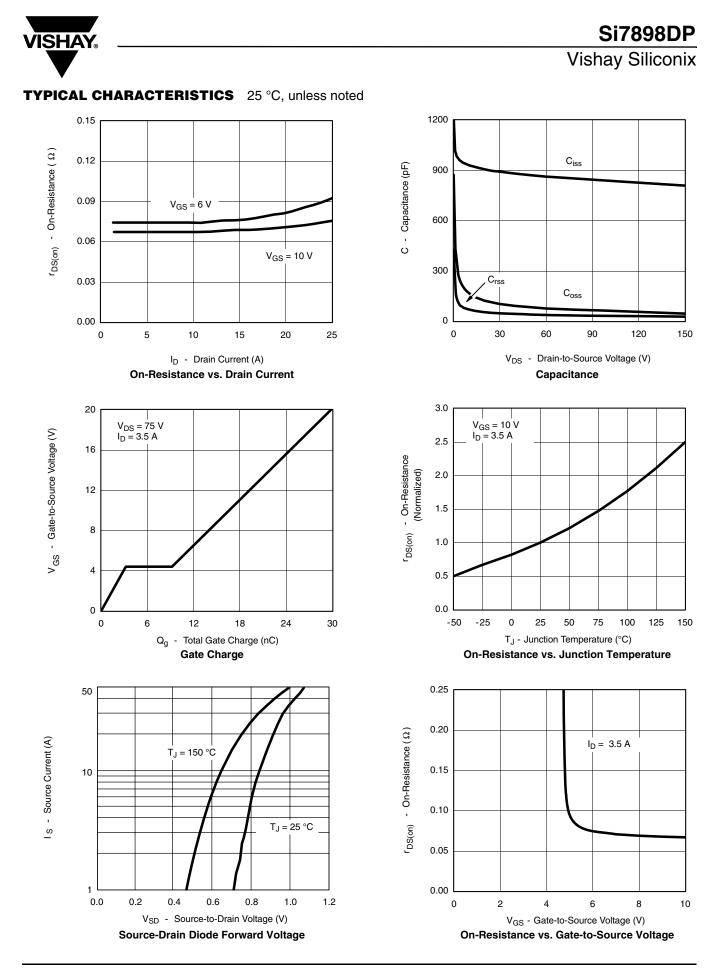
Notes a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless noted





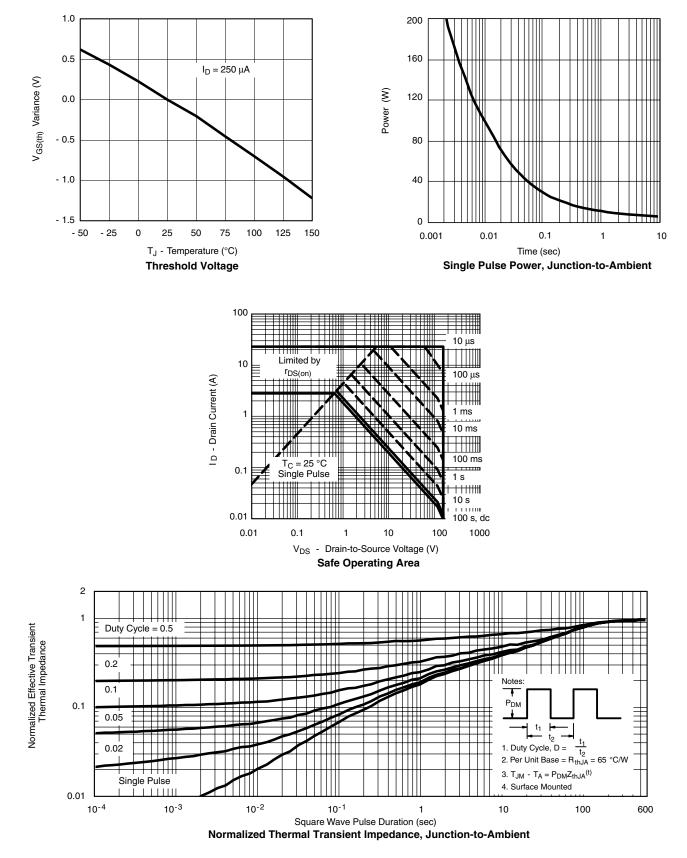


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Si7898DP

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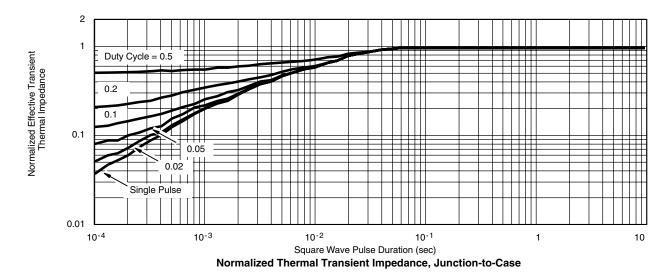




Si7898DP

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TYPICAL CHARACTERISTICS 25 °C, unless noted



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?71873.



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